Product brief

AW611_PB 1x1 Wi-Fi 6 and Bluetooth 5.2 Combo Solution Rev. 1 — 16 May 2023

1 Product overview

The AW611 is a highly integrated 2.4/5 GHz dual-band 1x1 Wi-Fi 6 and Bluetooth/ Bluetooth Low Energy 5.2 single-chip solution optimized for automotive applications such as in-vehicle infotainment (IVI), telematics, two-wheeler, or other automotive ECUs. This high degree of integration contributes to very low system costs and a minimum external BOM while achieving efficient co-existence between all internal radios as well as an external radio.

AW611 includes a full-feature Wi-Fi subsystem powered by NXP's 802.11ax (Wi-Fi 6) technology bringing higher throughput, better network efficiency, lower latency and improved range over previous generation Wi-Fi standards. The Wi-Fi subsystem integrates a Wi-Fi MAC, baseband, and direct-conversion radio with integrated PA, LNA, and transmit/receive switch removing the need for an RF front end module (FEMs) saving cost and reducing system complexity.

In addition to a Wi-Fi 6 radio, the AW611 integrates an independent Bluetooth 5.2 subsystem that supports Bluetooth and Bluetooth Low Energy (LE). The device features Bluetooth Profiles such as hands free (HFP), advanced audio distribution profile (A2DP) for audio streaming as well as additional profiles like dual wide band speech (WBS). For Bluetooth Low Energy, the AW611 enables 2 Mbit/s high speed data rate, long range, and extended advertising. Finally, LE Audio is supported utilizing Isochronous channels for a better overall audio experience.

AW611 supports two front-end antenna configurations: single-antenna (Figure 1) and dual-antenna (Figure 2).

The AW611 integrates dedicated CPUs and memories for both the Wi-Fi and Bluetooth subsystems, which enables real time, independent protocol processing. SDIO and UART interfaces are supported for connection to external host processors.

AECQ-100 grade 3 compliant and AECQ-100 grade 2 compliant, the AW611 provides SDIO 3.0 for Wi-Fi and UART for Bluetooth/Bluetooth LE host interfaces.



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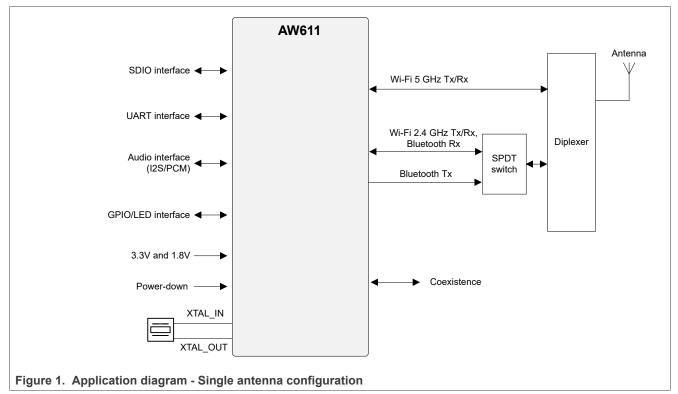
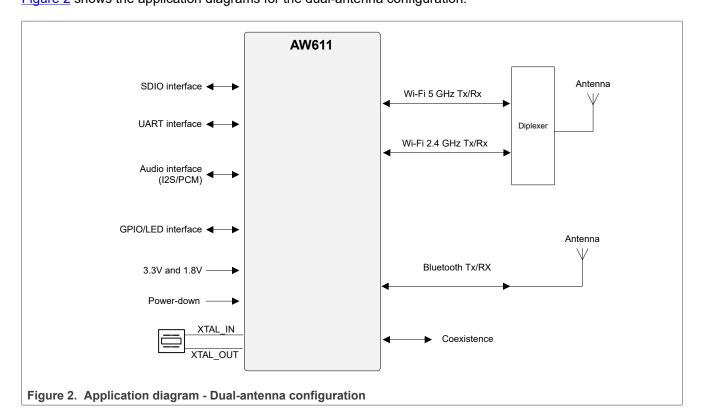


Figure 1 shows the application diagram for the single-antenna configuration.

Figure 2 shows the application diagrams for the dual-antenna configuration.



1.1 Applications

- Navigation
- Infotainment
- Telematics
- Hands-free audio
- User interface mirroring
- · Remote diagnostics
- Communication for EV charging

1.2 Product family devices

- AW611: Automotive AECQ-100 grade 2 and grade 3, Wi-Fi 6 and Bluetooth/Bluetooth Low Energy (LE)
- IW611: Wi-Fi 6 and Bluetooth/Bluetooth Low Energy (LE)
- IW612: Wi-Fi 6, Bluetooth/Bluetooth Low Energy (LE), and 802.15.4 Tri-radio

2 Wi-Fi subsystem

2.1 IEEE 802.11 standards

- 802.11ax 1x1 SU and MU-MIMO/OFDMA
- 802.11ac Wave 1/2 backward compatible
- 802.11n/a/g/b backward compatible
- 802.11d operation in additional regulatory domains
- 802.11az accurate ranging
- 802.11e quality of service
- 802.11h transmit power control
- 802.11h DFS radar pulse detection
- 802.11k radio resource measurement
- 802.11mc precise indoor location positioning
- 802.11r fast hand-off for AP roaming
- 802.11v BTM frame transmission/reception
- 802.11w protected management frames
- 802.11y ECSA
- 802.11z tunneled direct link setup
- Fully supports clients (stations) implementing IEEE Power Save mode

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2.2 Wi-Fi MAC

- 802.11ax 1x1 MU-MIMO MAC
- Trigger Frame Formats
 - Basic trigger frame
 - MU-BAR, MU-RTS, Beamforming Report Poll (BFRP), BSR Poll (BSRP) trigger variant
 - Trigger frame MAC padding
- HE Variants of HT Control
 - Basic format
 - UL Power Headroom
 - Receive Operation Mode control subfield
- HE MU Frame Exchange Sequences
- MU Acknowledgment (ACK)
- M-BA and C-BA Variants in BA Frames
- MU-RTS/CTS Procedures
- Target Wait Time Scheduling
- HE Dual-NAV
- UL Carrier Sensing
- Buffer Status Reports in response to BSRP trigger frames
- Operating Mode Indication (OMI)
- A-MPDU Rx (de-aggregation) and Tx (aggregation) (supports single-MPDU A-MPDU)
- Reduced Inter-Frame Spacing (RIFS) receive
- Management information base counters
- Radio resource measurement counters
- Quality of service queues
- Block acknowledgment extension
- Dynamic frequency selection
- Multiple-BSS/Station
- · Long and short preamble generation on a frame-by-frame basis for 802.11b frames
- Transmit rate adaptation
- Transmit power control
- Mobile hotspot

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2.3 Wi-Fi baseband

- 802.11ax 1x1 MU-MIMO baseband, backward compatible with 802.11ac/n/a/g/b technology
- Bandwidth support
 - 20 MHz
 - **–** 40 MHz
 - 80 MHz
- Modulation and Coding Schemes (MCS)
 - 802.11ax-MCS0~11
 - 802.11ac-MCS0~9
 - 802.11n-MCS0~7
 - Dual Sub-Carrier Modulation (DCM)
 - MCS0
 - BCC and LDPC coding
- Frame Formats
 - 802.11ax HE_SU (Tx/Rx)
 - 802.11ax HE_MU (Rx)
 - 802.11ax HE_ER_SU (Tx/Rx)
 - 802.11ax HE_TB (Tx)
 - **–** 802.11ac VHT
 - 802.11n HT
 - 802.11a (including dup/quad modes)
 - 802.11g (including dup mode)
 - **–** 802.11b
- Uplink MU-MIMO Tx as STA
- Downlink MU-MIMO Rx as STA
- Aggressive Packet Extension
- Range Extension
- Receiver Beam Change
- Guard Interval Modes
 - 1x HE-LTF with 0.8 us GI
 - 1x HE-LTF with 1.6 us GI (for UL TB PPDU)
 - 2x HE-LTF with 0.8 us GI
 - 2x HE-LTF with 1.6 us GI
 - 4x HE-LTF with 3.2 us GI
 - 4x HE-LTF with 0.8 us GI
- Dynamic Frequency Selection (DFS) (radar detection)
- Optional 802.11ac and 802.11n MIMO features:
 - 20/40/80 MHz coexistence with middle-packet detection (GI detection) for enhanced CCA
 - LDPC transmission and reception for both 802.11ac and 802.11n
 - Short guard interval (0.4 us)
 - RIFS on receive path for 802.11n packets
 - VHT MU-PPDU (receive)
- Spectral intelligence
- Spectrum monitoring
- DFS assist to reduce false detections
- Interference identification/classification

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Power save features

2.4 Wi-Fi radio

- 5 GHz and 2.4 GHz Wi-Fi band operation
- 802.11ax 1x1 MU-MIMO on-chip RF radio
- Integrated PA, LNA

2.5 RF channels

Table 1 shows the list of supported channels for 2.4 GHz and 5 GHz.

Channel number	Frequency	Channel number	Frequency	Channel number	Frequency
			2.4 GHz channel	I	
1	2412 MHz	2	2417 MHz	3	2422 MHz
4	2427 MHz	5	2432 MHz	6	2437 MHz
7	2442 MHz	8	2447 MHz	9	2452 MHz
10	2457 MHz	11	2462 MHz	12	2467 MHz
13	2472 MHz	—	—	—	—
			5 GHz channel		
36	5180 MHz	40	5200 MHz	44	5220 MHz
48	5240 MHz	52	5260 MHz	56	5280 MHz
60	5300 MHz	64	5320 MHz	100	5500 MHz
104	5520 MHz	108	5540 MHz	112	5560 MHz
116	5580 MHz	120	5600 MHz	124	5620 MHz
128	5640 MHz	132	5660 MHz	136	5680 MHz
140	5700 MHz	144	5720 MHz	149	5745 MHz
153	5765 MHz	157	5785 MHz	161	5805 MHz
165	5825 MHz	169	5845 MHz	173	5865 MHz
177	5885 MHz	—	—	—	—
184	4920	187	4935	188	4940
192	4960	196	4980	—	—
8	5040	11	5055	12	5060
16	5080	_			_

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2.6 Wi-Fi encryption

- Supports WPA2 and WPA3 personal and enterprise
- Data Frame Encryption/Decryption
 - Advanced Encryption Standard (AES) / Counter-Mode/CBC-MAC Protocol (CCMP)
 - Advanced Encryption Standard (AES) / Galois/Counter Mode Protocol (GCMP)
 - WLAN Authentication and Privacy Infrastructure (WAPI)
- Management Frame Encryption/Decryption for broadcast/multicast packets
- Advanced Encryption Standard (AES) / Cipher-based Message Authentication Code (CMAC)
 BIP-GMAC
- Management Frame Encryption/Decryption for unicast packets
 - AES/CCMP
 - AES/GCMP

2.7 Beamforming

802.11ax/ac/n Explicit Beamformee
 Supports sounding feedback for up to 4x4 Beamformer

2.8 Wi-Fi host interface

• SDIO 3.0 (4-bit SDIO and 1-bit SDIO) with transfer rates up to SDR104 (208 MHz)

3 Bluetooth subsystem

3.1 Bluetooth features

- Bluetooth 5.2 features
- Bluetooth Class 2
- Bluetooth Class 1
- Single-ended, shared Tx/Rx path for Bluetooth
- I2S/PCM interface for voice applications
- Baseband/radio BDR/EDR packet types—1 Mbps (GFSK), 2 Mbps (π /4-DQPSK), 3 Mbps (8DPSK)
- Fully functional Bluetooth baseband—AFH, forward error correction, header error control, access code correlation, CRC, encryption bit stream generation, and whitening
- Interlaced scan for faster connection setup
- · Simultaneous active ACL connection support
- Automatic ACL packet type selection
- Full central¹ and peripheral¹ piconet support
- Scatternet support
- Standard UART HCI transport layer
- HCI layer to integrate with profile stack
- SCO/eSCO links with hardware accelerated audio signal processing and hardware supported PPEC algorithm for speech quality improvement
- All standard SCO/eSCO voice coding
- A2DP support
- · All standard pairing, authentication, link key, and encryption operations
- Standard Bluetooth power-saving mechanisms (hold, sniff modes, and sniff subrating)
- Enhanced Power Control (EPC)
- Channel Quality Driven Data Rate (CQDDR)
- Wideband Speech (WBS) support (2 WBS links)
- Encryption (AES) support

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¹ The master/slave replacement in this document follows the recommendation of Bluetooth SIG.

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3.2 Bluetooth Low Energy (LE) features

- Bluetooth LE 5.3
- Supports up to 16 simultaneous central²/peripheral² connections
- Wi-Fi/Bluetooth coexistence protocol support
- Shared RF with BDR/EDR
- Encryption (AES) support
- Intelligent Adaptive Frequency Hopping (AFH)
- Bluetooth LE Privacy 1.3
- Bluetooth LE Secure Connection
- Bluetooth LE Data Length Extension
- Bluetooth LE Advertising Extension
- Bluetooth LE Long Range
- Bluetooth LE 2 Mbps
- Bluetooth LE power control
- Bluetooth LE isochronous channels³

3.3 Bluetooth host interface

• High-Speed UART with support up to 3 Mbps baud rate

3 Bluetooth LE audio supported with external host running Low Complexity Communication codec (LC3) through HCI interface

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² The master/slave replacement in this document follows the recommendation of Bluetooth SIG.

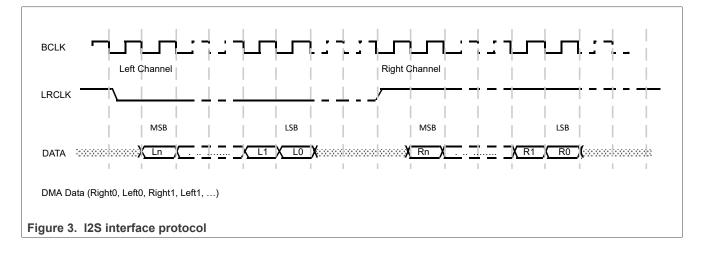
3.4 Digital audio interfaces

3.4.1 I2S interface

- Central⁴ or peripheral⁴ mode
- I2S (Inter-IC Sound) interface for audio data connection to Analog-to-Digital Converters (ADC) and Digital-to-Analog Converters (DAC)
- 3-state I2S interface capability
- I2S pins shared with PCM pins
- Supports clock speeds of 4.096 MHz, 2.048 MHz, and 2 MHz

3.4.1.1 I2S interface protocol

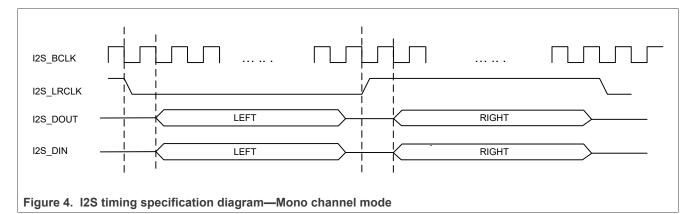
Figure 3 shows I2S interface protocol.



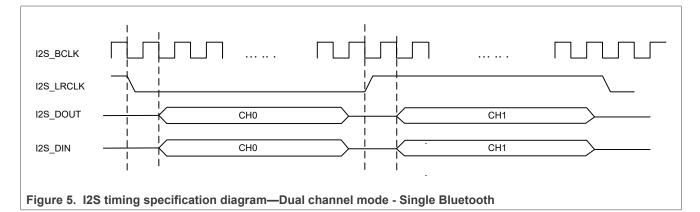
⁴ The master/slave replacement in this document follows the recommendation of Bluetooth SIG.

AW611 supports mono and dual channel modes.

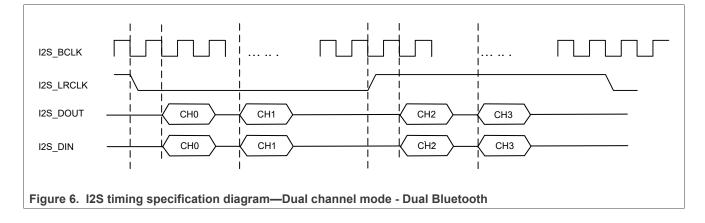
In mono-channel mode, by default the left channel is used for data.



In dual-channel mode, the two channels are supported on two time slots.



With dual Bluetooth, the channel pair CH0 + CH2 is for one Bluetooth, and the channel pair CH1 + CH3 is for the second Bluetooth.



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3.4.1.2 Clock frequency and audio data resolutions

Audio data may arrive with different input data formats with different sampling rates.

In central⁵ mode, the I2S interface uses an audio input clock of 4.096 MHz or 2.048 MHz to provide the appropriate M clock (MCLK) and bit clock (I2S_BCLK) frequency to match the sampling rates of each audio data format. The sampling rates can be 8 kHz to 16 kHz.

In peripheral⁵ mode, the I2S interface does not provide the bit clock (I2S_BCLK) but it can provide the M clock (MCLK).

⁵ The master/slave replacement in this document follows the recommendation of Bluetooth SIG.

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3.4.2 PCM interface

- Central⁶ or peripheral⁶ mode
- PCM bit width size of 8 bits or 16 bits
- Up to four slots with configurable bit width and start positions
- 3-state PCM interface capability
- PCM short frame and long frame⁷ synchronization
- PCM pins shared with I2S pins
- Supports clock speeds of 4.096 MHz, 2.048 MHz, and 2 MHz

3.4.2.1 PCM protocol

The PCM interface supports long and short frame sync. <u>Figure 7</u> and <u>Figure 8</u> show an example of a PCM interface with four signals.

PCM_SYNC]
PCM_CLK								
PCM_DOUT		MSb	MSb-1	MSb-2	MSb-3	 d1	d0l]
PCM_DIN	Don't Care	MSb	MSb-1	MSb-2	MSb-3	 d1	d0	Don't Care
Figure 7. P	CM long frame sync							

PCM_SYNC									
PCM_CLK						 -			
PCM_DOUT		MSb	MSb-1	MSb-2	MSb-3]	d1	d0	
PCM_DIN	Don't Care	MSb	MSb-1	MSb-2	MSb-3]	d1	d0	Don't Care
Figure 8. PC	M short frame sync								

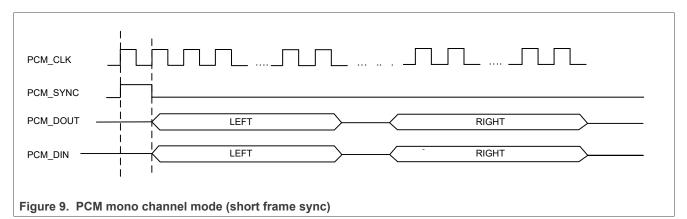
⁶ The master/slave replacement in this document follows the recommendation of Bluetooth SIG.

⁷ In PCM central mode, PCM long frame synchronization is 1 clock wide. In PCM peripheral mode, PCM central long frame synchronization pattern is supported.

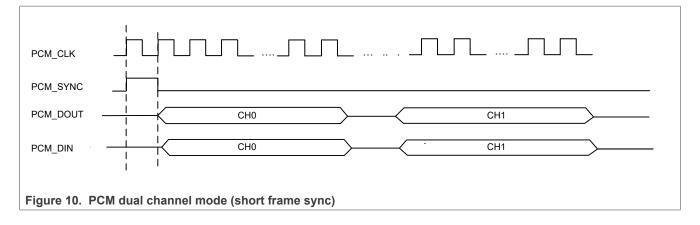
AW611 supports mono and dual channel modes.

Note: <u>Figure 9</u> and <u>Figure 10</u> illustrate PCM mono and dual channel modes in short frame sync. The same applies to long frame sync.

In mono-channel mode, by default the left channel is used for data.



In dual-channel mode, the two channels are supported on two time slots.



3.4.2.2 PCM modes of operation

The PCM interface supports two modes of operation:

- PCM central⁸
- PCM peripheral⁸

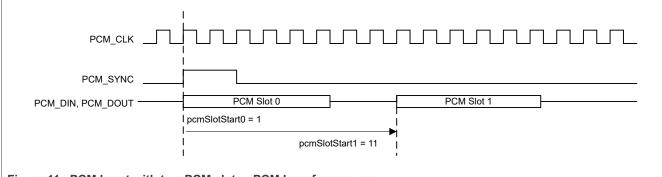
When in PCM central⁸ mode, the interface generates a 2 MHz or a 2.048 MHz PCM_CLK and 8 kHz

PCM_SYNC signal. An alternative PCM central⁸ mode is available that uses an externally generated PCM_CLK, but still generates the 8 kHz PCM_SYNC. The external PCM_CLK must have a frequency that is an integer multiple of 8 kHz. Supported frequencies are in the 512 kHz to 4 MHz range.

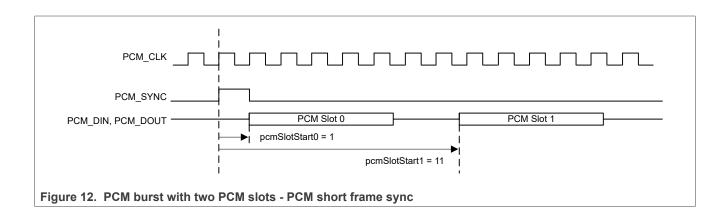
When in PCM peripheral⁸ mode, the interface has both PCM_CLK and PCM_SYNC as inputs, thereby letting another unit on the PCM bus generate the signals.

The PCM interface consists of up to four PCM slots (time divided) preceded by a PCM sync signal. Each PCM slot can be either 8 or 16 bits wide. The slots can be separated in time, but are not required to follow immediately after one other. The timing is relative to PCM_CLK. Figure 12 shows an example of a PCM burst with two slots.

The burst starts with a PCM_SYNC and then follows the PCM burst. In this example, the PCM burst consists of two PCM slots (the first slot is 8 bits wide, the second slot is 16 bits wide) separated with two PCM_CLK clock cycles. The PCM slots can be configured to start at an arbitrary point in time, and the start value is given relative to the start of the PCM_SYNC. The timing of the four PCM slots must be such that slot 0 is always located before slot 1, slot 1 before slot 2, etc. It is possible to only use for example slot 1 and not slot 0.







8 The central/peripheral replacement in this document follows the recommendation of Bluetooth SIG.

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4 Revision history

Table 2. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
AW611 v.1.0	20230516	Product brief	-	-

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